



SOT223 N-CHANNEL ENHANCEMENT MODE VERTICAL DMOS FET

Product Summary

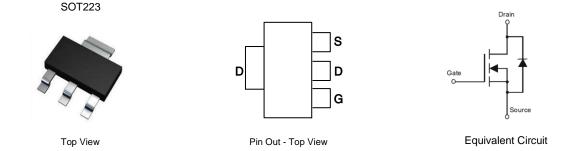
| BV _{DSS} | | R _{DS(ON)} | I _D T _A = +25°C | |
|-------------------|----|------------------------------|--|--|
| 10 | 0V | 1.5Ω @ V _{GS} = 10V | 800mA | |

Features and Benefits

- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOT223
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See Diagram Below
- Terminals: Finish Matte Tin Annealed over Copper Lead Frame. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.112 grams (Approximate)



Ordering Information (Note 4)

| Part Number | Marking | Reel Size (inches) | Tape Width (mm) | Quantity Per Reel |
|-------------|---------|--------------------|-----------------|-------------------|
| ZVN4210GTA | ZVN4210 | 7 | 8 | 1,000 |

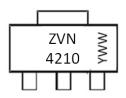
Notes: 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied. 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green"

 See http://www.diodes.com/quality/lead_free.html and Lead-free.

3. Halogen - and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.</p>

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



 $\begin{array}{l} {\sf ZVN4210} = {\sf Product Type Marking Code} \\ {\sf YWW} = {\sf Date Code Marking} \\ {\sf Y or } \overrightarrow{{\sf Y}} = {\sf Year (ex: 5 = 2015)} \\ {\sf WW or } \overrightarrow{{\sf WW}} = {\sf Week (01 to 53)} \end{array}$



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

| Characteristic | | Symbol | Value | Unit |
|--|------------------------|------------------|-------|------|
| Drain-Source Voltage | V _{DSS} | 100 | V | |
| Gate-Source Voltage | | V _{GSS} | ±20 | V |
| Continuous Drain Current V _{GS} = 10V | T _A = +25°C | ID | 800 | mA |
| Pulsed Drain Current | - - | I _{DM} | 6 | А |

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit | |
|---|----------------------------------|-------------|------|---|
| Total Power Dissipation | T _A = +25°C | PD | 2 | W |
| Operating and Storage Temperature Range | T _{J,} T _{STG} | -55 to +150 | °C | |

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

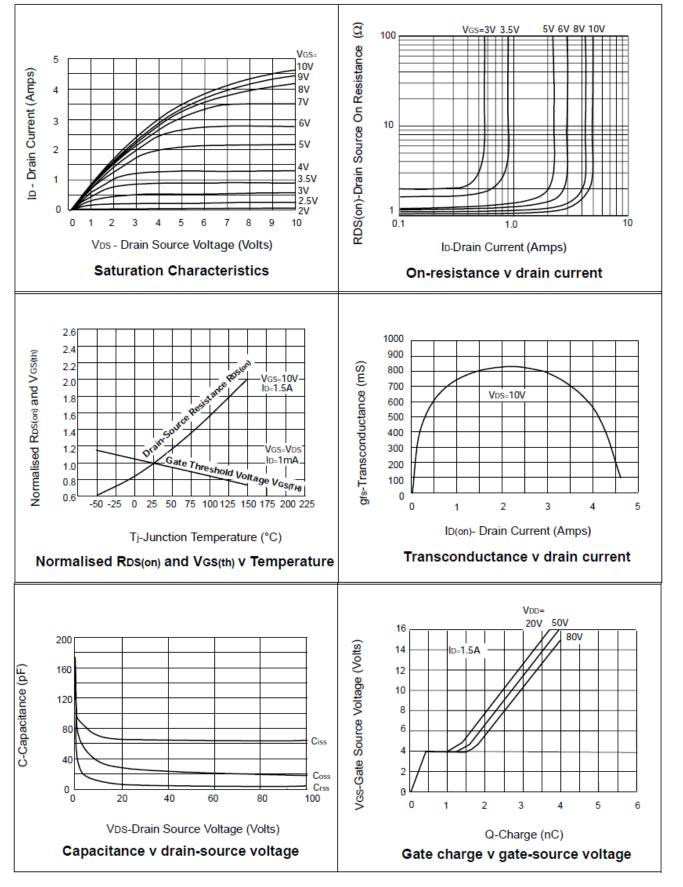
| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition | |
|--|---------------------|-----|--------------|-----------|----------|---|--|
| OFF CHARACTERISTICS | | | - 71- | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | 100 | - | - | V | $V_{GS} = 0V, I_D = 1mA$ | |
| Zero Gate Voltage Drain Current | I _{DSS} | - | - | 10 100 | μΑ μΑ | V _{DS} = 100V, V _{GS} = 0V V _{DS} =80V, V _{GS} =0V, T=125°C (Note 6) | |
| Gate-Source Leakage | I _{GSS} | _ | _ | ±100 | nA | $V_{GS} = \pm 20V, V_{DS} = 0V$ | |
| ON CHARACTERISTICS | 000 | | 1 | | | | |
| Gate Threshold Voltage | V _{GS(TH)} | 0.8 | - | 2.4 | V | $V_{DS} = V_{GS}, I_D = 1mA$ | |
| Statia Dusia Course On Desistance | _ | _ | - | 1.5 | Ω | V _{GS} = 10V, I _D = 1.5A | |
| Static Drain-Source On-Resistance | R _{DS(ON)} | _ | - | 1.8 | Ω | $V_{GS} = 5V, I_D = 0.5A$ | |
| Diode Forward Voltage (Note 5) | V _{SD} | - | 0.79 0.89 | - | V | $I_{S} = 0.32A, V_{GS} = 0V$ $I_{S} = 1.0A, V_{GS} = 0V$ | |
| On-State Drain Current (Note 5) | I _{D(ON)} | 2.5 | - | - | А | V _{DS} =25V, V _{GS} =10V | |
| Forward Transconductance (Notes 5 and 6) | g _{fs} | 250 | - | - | mS | V _{DS} =25V,I _D =1.5A | |
| Reverse Recovery Time (to $I_R = 10\%$) | t _{RR} | _ | 135 | _ | ns | $I_{F} = 0.45A, V_{GS} = 0V, I_{R} = 100mA, V_{R} = 10V$ | |
| DYNAMIC CHARACTERISTICS (Note 6) | | | | | | | |
| Input Capacitance | C _{iss} | _ | - | 100 | рF | | |
| Output Capacitance | Coss | _ | - | 40 | pF | $V_{DS} = 25V, V_{GS} = 0V, f = 1MHz$ | |
| Reverse Transfer Capacitance | Crss | - | - | 12 | pF | | |
| Turn-On Delay Time (Note 7) | t _{D(ON)} | - | - | 4 | ns | | |
| Turn-On Rise Time (Note 7) | t _R | - | _ | 8 | ns | | |
| Turn-Off Delay Time (Note 7) | t _{D(OFF)} | - | - | 20 | ns | $V_{DD} = 25V, I_{D} = 1.5A$ | |
| Turn-Off Fall Time (Note 7) | t _F | - | - | 30 | ns | | |

5. Measured under pulsed conditions. Width=300 μ s. Duty cycle $\leq 2\%$. Notes:

6. Sample test.
7. Switching times measured with 50Ω source impedance and <5ns rise time on a pulse generator. Spice parameter data is available upon request for this device



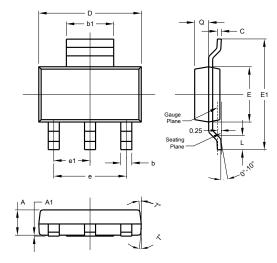
Electrical Characteristics





Package Outline Dimensions

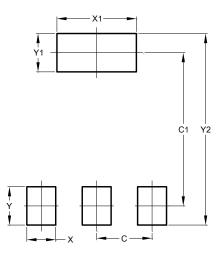
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



| SOT223 | | | | | |
|----------------------|-------|------|------|--|--|
| Dim | Min | Max | Тур | | |
| Α | 1.55 | 1.65 | 1.60 | | |
| A1 | 0.010 | 0.15 | 0.05 | | |
| b | 0.60 | 0.80 | 0.70 | | |
| b1 | 2.90 | 3.10 | 3.00 | | |
| С | 0.20 | 0.30 | 0.25 | | |
| D | 6.45 | 6.55 | 6.50 | | |
| Е | 3.45 | 3.55 | 3.50 | | |
| E1 | 6.90 | 7.10 | 7.00 | | |
| е | - | - | 4.60 | | |
| e1 | - | - | 2.30 | | |
| L | 0.85 | 1.05 | 0.95 | | |
| Q | 0.84 | 0.94 | 0.89 | | |
| All Dimensions in mm | | | | | |

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



| Dimensions | Value (in mm) | | |
|------------|---------------|--|--|
| С | 2.30 | | |
| C1 | 6.40 | | |
| Х | 1.20 | | |
| X1 | 3.30 | | |
| Y | 1.60 | | |
| Y1 | 1.60 | | |
| Y2 | 8.00 | | |



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